ES1ABF THRU ES1JBF

Surface Mount Superfast Recovery Rectifier

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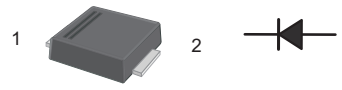
Reverse Voltage – 50 to 600 V

Forward Current – 1 A

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Simplified outline SMBF and symbol

FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case: SMBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 57mg / 0.002oz

Absolute Maximum Ratings and Characteristics

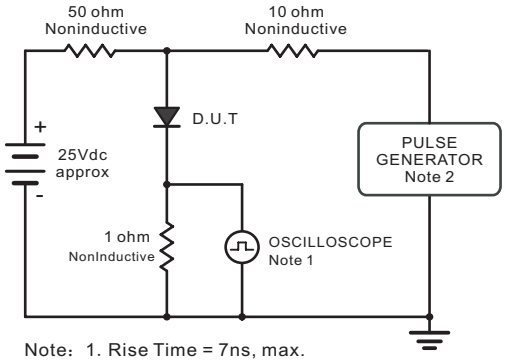
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	ES1ABF	ES1BBF	ES1CBF	ES1DBF	ES1EBF	ES1GBF	ES1JBF	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at T_L = 100 °C	$I_{F(AV)}$	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	35							A
Maximum Forward Voltage at 1 A	V_F	1				1.25		1.65	V
Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta =125 °C	I_R	5 100							μA
Typical Junction Capacitance at V_R=4V, f=1MHz	C_j	10							pF
Maximum Reverse Recovery Time [1]	t_{rr}	35							ns
Typical Thermal Resistance [2]	$R_{\theta JA}$	85							°C/W
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150							°C

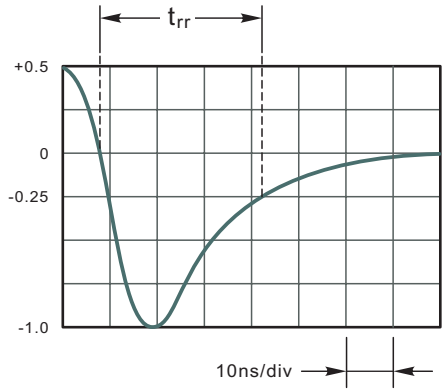
1) Measured with IF = 0.5 A, IR = 1 A, Irr = 0.25 A

2) P.C.B. mounted with 0.5 X 0.5" (12.7 X 12.7 mm^2) copper pad areas.

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm,22pF.
2. Ries Time =10ns, max.
Source Impedance = 50 ohms.



Set time Base for 10ns/div

Fig.2 Maximum Average Forward Current Rating

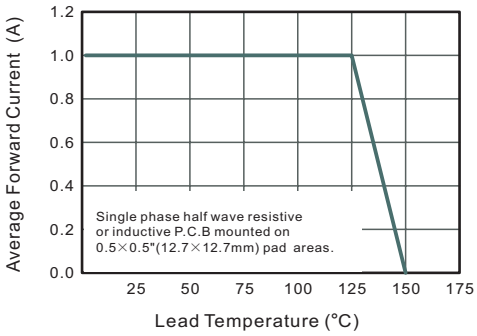


Fig.3 Typical Reverse Characteristics

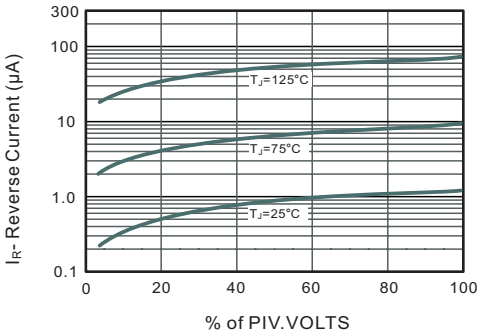


Fig.4 Typical Forward Characteristics

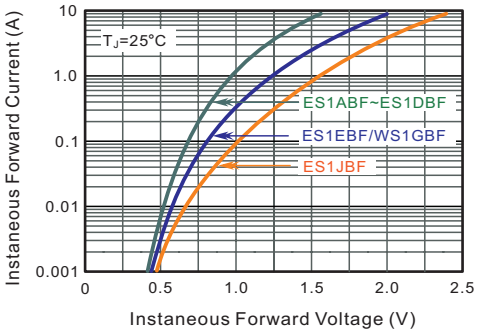


Fig.5 Typical Junction Capacitance

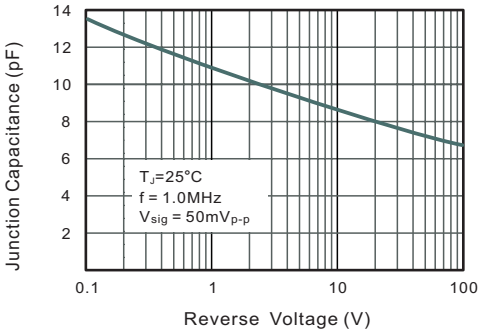
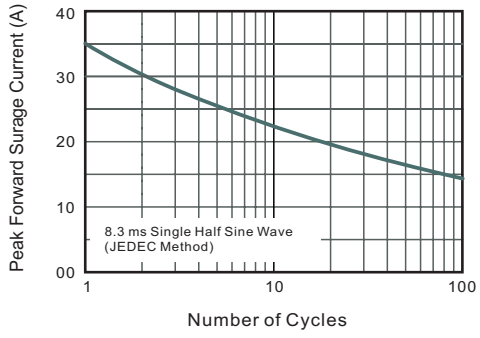


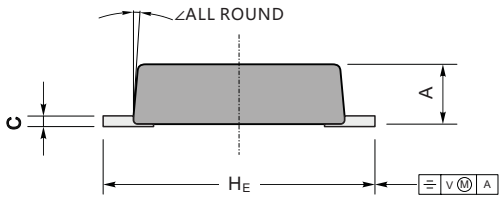
Fig.4 Maximum Non-Repetitive Peak Forward Surage Current

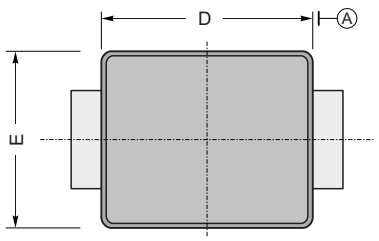


PACKAGE OUTLINE

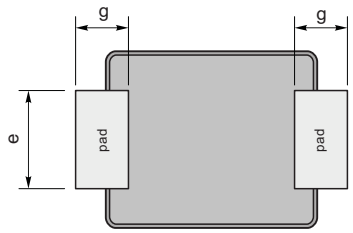
Plastic surface mounted package; 2 leads

SMBF





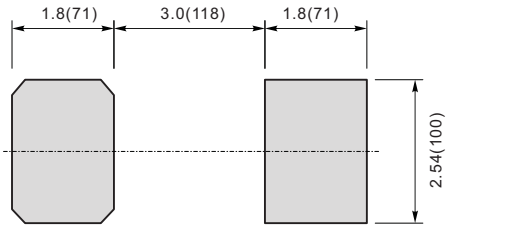
Top View



Bottom View

UNIT		A	C	D	E	H_E	e	g	∠
mm	max	1.3	0.26	4.4	3.7	5.5	2.2	1.0	9°
	min	1.1	0.18	4.2	3.5	5.1	1.9		
mil	max	51	10	173	146	216	86	40	
	min	43	7	165	138	200	75		

The recommended mounting pad size



Unit: mm(mil)

Marking

Type number	Marking code
ES1ABF	E1AB
ES1BBF	E1BB
ES1CBF	E1CB
ES1DBF	E1DB
ES1EBF	E1EB
ES1GBF	E1GB
ES1JBF	E1JB